

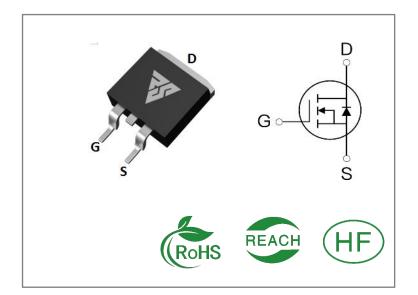
ID	R _{DS} (ON)(Typ)	VDSS
140A	4.5m $Ω$	85V

Applications:

- Load Switch
- PWM Applications
- Power Managment

Features:

- Fast switching speed
- 100% avalanche tested
- Improved dv/dt capability



Ordering Information

Part Number	Package	Marking	Packing	Qty.
RS85N140S	T0-263	RS85N140S	Tape&reel	800 PCS

Absolute Maximun Ratings Tc= 25℃ unless otherwise specified

Symbol	Parameter	RS85N140S	Units
VDSS	Drain-to-Source Voltage	85	V
ID	Continuous Drain Current TC=25℃	140	
ID	Continuous Drain Current TC=100℃	125	Α
IDM	Pulsed Drain Current	490	
PD	Power Dissipation	175	W
VGS	Gate- to- Source Voltage	±20	V
EAS	Single Pulse Avalanche Engergy L = 0.5mH,VDD = 50V, RG = 25Ω , Tj = 25° C	150	mJ
	Maximum Temperature for Soldering		
TL TPKG	Leads at 0.063in(1.6mm)from Case for 10 seconds Package Body for 10 seconds	300 260	${}^{\circ}\!$
TJ and TSTG	Operating Junction and Storage Temperature Range	-55 to 150	

^{*} Drain Current Limited by Maximum Junction Temperature

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" Table may cause permanent damage to the device.



Thermal Resistance

Symbol	Parameter	RS85N140S	Units	Test Conditions
RθJC	Junction-to-Case	0.7	°C/W	Drain lead soldered to water cooled heatsink, PD adjusted for a peak junction temperature of + 1 5 0 $^{\circ}$ C
RθJA	Junction-to- Ambient	62		1 cubic foot chamber,free air.

OFF Characteristics TJ= 25℃ unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BVDSS	Drain- to- source Breakdown Voltage	85			V	VGS=0V,ID=250μ A
IDSS	Drain- to- Source Leakage Current			1	μΑ	VDS=80V,VGS=0 V
IGSS	Gate- to- Source Forward Leakage			100	- A	VGS=20V ,VDS=0 V
1033	Gate- to- Source Reverse Leakage			-100	nA	VGS=-20V ,VDS= 0V

ON Characteristics TJ=25°C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
RDS(on)	Static Drain- to- Source On- Resistance		4.5	5.3	mΩ	VGS=10V,ID=50A
VGS(TH	Gate Threshold Voltage	2.1		4.1	V	VGS=VDS,ID=25 0μA

Resistive Switching Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
td(ON)	Turn- on Delay Time		20			
trise	Rise Time		38.7			VDS=40V
td(OFF)	Turn- OFF Delay Time		46		nS	RG=3Ω VGS=10V
tfall	Fall Time		23			



Dynamic Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Ciss	Input Capacitance		3090			VGS= 0V
Coss	Output Capacitance		30		pF	VDS=40V
Crss	Reverse Transfer Capacitance		55			f=1MHz
Qg	Total Gate Charge		55			VDS= 50V
Qgs	Gate- to- Source Charge		15		nC	ID=40A
Qgd	Gate-to-Drain(" Miller") Charge		12			VGS=10V

Source-Drain Diode Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
IS	Continuous Source Current			140	Α	Integral pn- diode
ISM	Maximum Pulsed Current			490	Α	in MOSFET
VSD	Diode Forward Voltage			1.4	V	IS=50A,VGS=0V
trr	Reverse Recovery Time		60		nS	VGS=0V
Qrr	Reverse Recovery Charge		565		nC	IS=20A di/dt=100A/μs

Notes:

- * 1. Repetitive rating, pulse width limited by maximum junction temperature.
- * 2. Pulse Test: Pulse width ≤ 300µs, Duty Cycle ≤ 1%

Typical Feature Curve

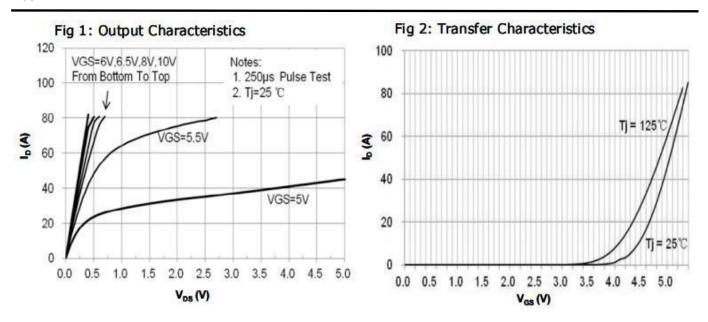


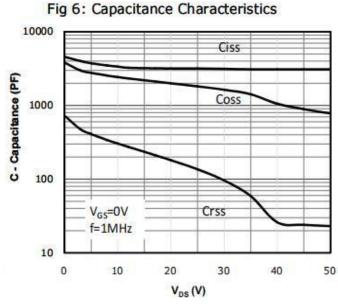


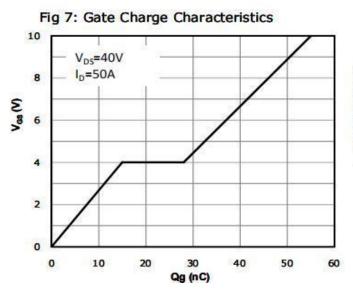
Fig 3: Rds(on) vs Drain Current and Gate Voltage 7.0 6.0 Rosion) (ma) 5.0 Vcc=10V 4.0 3.0 2.0 100 10 20 30 40 50 60 70 80 90 ID (A)

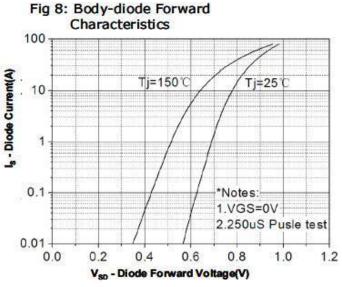
Fig 4: Rds(on) vs Gate Voltage

10⁰
10⁻¹
10⁻²
10⁻³
2
4
6
8
10

Fig 5: Rds(on) vs. Temperature 2.0 V_{GS}=10V 1.8 I_D=50A Ros(on)_Normalized 1.6 1.4 1.2 1.0 0.8 0.6 0.4 25 50 100 125 150 175 75 Tj - Junction Temperature (°C)









0.001

1E-05

0.0001

Fig 10: Drain Current Derating Fig 9: Power Dissipation V_{GS}≥10V Tc - Case Temperature (°C) Tc - Case Temperature (°C)

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t_p (sec)

0.01

0.1

0.001



Test ircuits and Waveforms

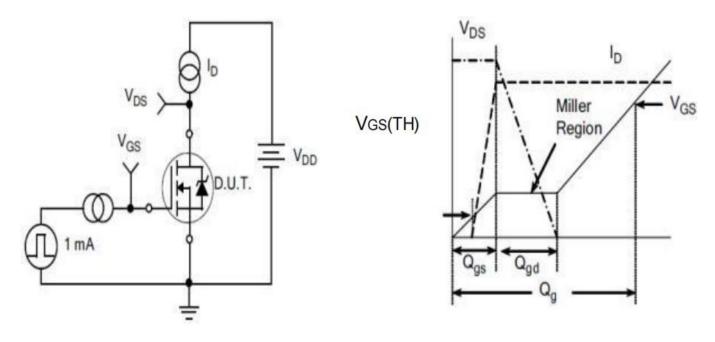


Figure A.
Gate Charge Test Circuit

A. Figure B. Gate Charge Waveform

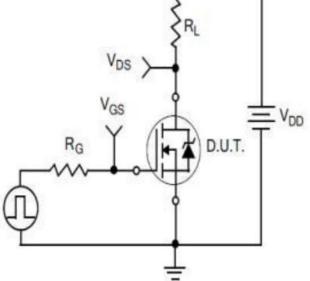


Figure C.
Resistive Switching Test Circuit

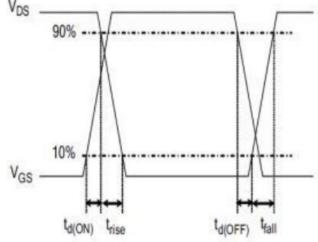
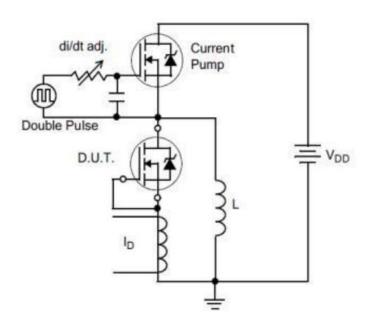


Figure D.
Resistive Switching Waveforms



Test ircuits and Waveforms



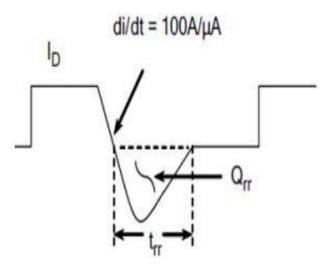


Figure E.Diode Reverse Recovery Test Circuit

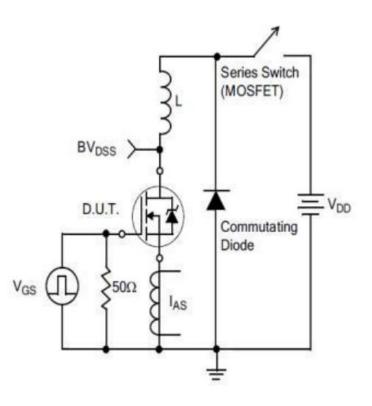


Figure F.Diode Reverse Recovery Waveform

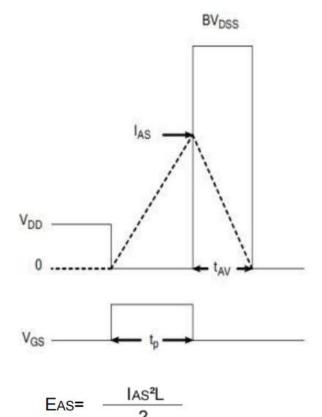


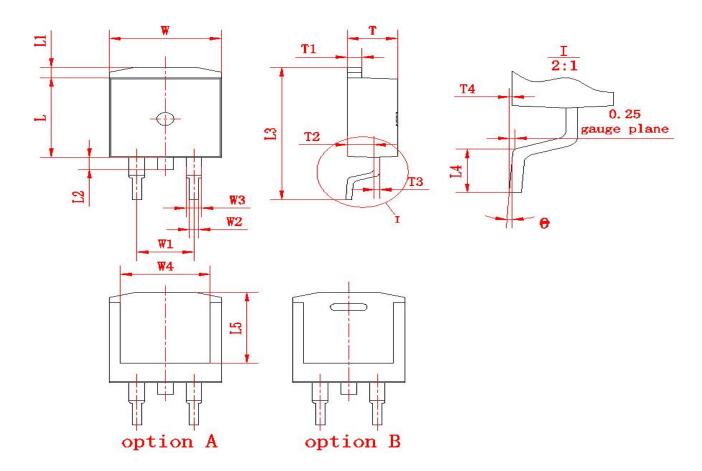
Figure G.Unclamped Inductive Switching Test Circuit

Figure H.Unclamped Inductive Switching Waveforms

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Package outline drawing(TO-263 Unit: mm)



(单位: mm)

符号	尺寸		符号	尺寸		かロ	尺寸	
गिर	Min	Max	x Min Max	Max	符号	Min	Max	
W	9. 80	10. 20	L1	1.00	1.40	T1	1. 20	1. 40
W1	(5. 08)		L2	1. 20	1.60	T2	2. 20	2. 60
W2	0. 70	0. 95	L3	15. 00	15. 60	T3	0. 45	0. 65
W 3	1. 17	1. 62	L4	2. 20	2. 80	T4	0	0. 25
W4	(8)	. 0)	L5	(8. 2)		θ	0°	8°
L	9.00	9. 40	T	4. 30	4. 70			



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